



# N-Channel 40-V (D-S), 175 °C MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	I <sub>D</sub> (A) <sup>a, c</sup>	Q <sub>g</sub> (Typ.)		
40	0.016 at V <sub>GS</sub> = 10 V	20	15.6 nC		
	0.018 at V <sub>GS</sub> = 4.5 V	20	13.0110		

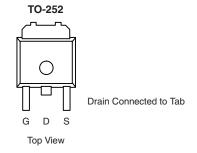
#### **FEATURES**

- TrenchFET® Power MOSFET
- 100 %  $\rm R_{\rm g}$  and UIS Tested

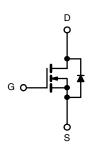


#### **APPLICATIONS**

- LCD TV Inverter
- Secondary Synchronous Rectification



Ordering Information: SUD50N04-16P-E3 (Lead (Pb)-free)



N-Channel MOSFET

<b>ABSOLUTE MAXIMUM RATINGS</b>	T <sub>A</sub> = 25 °C, unles	s otherwise n	oted		
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		$V_{DS}$	40	V	
Gate-Source Voltage		$V_{GS}$	± 16		
	T <sub>C</sub> = 25 °C		20 <sup>c</sup>		
Continuous Prain Current (T = 150 °C)	T <sub>C</sub> = 100 °C	1 ,	20 <sup>c</sup>	1	
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	9.8 <sup>b</sup>	A	
	T <sub>A</sub> = 100 °C		6.8 <sup>b</sup>		
Pulsed Drain Current		I <sub>DM</sub>	50	7 ^	
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	1	20 <sup>c</sup>		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	2.5 <sup>b</sup>		
Single Pulse Avalanche Current	1 0.1 ml l	I <sub>AS</sub>	20		
Avalanche Energy L = 0.1 mH		E <sub>AS</sub>	20	mJ	
	T <sub>C</sub> = 25 °C		35.7	W	
Maximum Dawar Dissination	T <sub>C</sub> = 100 °C	D	17.8		
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	3.1 <sup>b</sup>		
	T <sub>A</sub> = 100 °C		1.5 <sup>b</sup>		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>b</sup>	Steady State	R <sub>thJA</sub>	40	50	°C/W	
Maximum Junction-to-Case	Steady State	R <sub>thJC</sub>	3.4	5.3		

#### Notes:

- a. Based on  $T_C = 25$  °C.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. Package limited.

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<b>SPECIFICATIONS</b> T <sub>J</sub> = 25 °C, unless otherwise noted								
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit		
Static				•		,		
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0 \text{ V, I}_{D} = 250 \mu\text{A}$	40			V		
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 250 μA		38		mV/°C		
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	5 .		- 5.4				
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	8.0		2.2	V		
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 16 \text{ V}$			± 100	nA		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 100 ^{\circ}\text{C}$			1 20	μΑ		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30			Α		
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 15 A		0.0125	0.016			
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 10 A		0.014	0.018	Ω		
Forward Transconductance <sup>a</sup>	g <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 15 A		58		S		
Dynamic <sup>b</sup>	015	, DO , D				l		
Input Capacitance	C <sub>iss</sub>			1655		pF		
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V, f = 1 MHz		200				
Reverse Transfer Capacitance	C <sub>rss</sub>			152				
<u> </u>		$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 30 \text{ A}$		39.2	60			
Total Gate Charge	$Q_g$	30 00 2		15.6	24			
Gate-Source Charge	$Q_{gs}$	$V_{DS} = 20 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 30 \text{ A}$		4.2		nC		
Gate-Drain Charge	$Q_{gd}$			5.5		1		
Gate Resistance	$R_{q}$	f = 1 MHz		2.1	3.2	Ω		
Turn-On Delay Time	t <sub>d(on)</sub>			19	30	ns		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 20 V, $R_L$ = 0.66 Ω $I_D$ $\cong$ 30 A, $V_{GEN}$ = 4.5 V, $R_g$ = 1 Ω		120	180			
Turn-Off Delay Time	t <sub>d(off)</sub>			40	60			
Fall Time	t <sub>f</sub>			36	55			
Turn-On Delay Time	t <sub>d(on)</sub>			8	16			
Rise Time	t <sub>r</sub>	$V_{DD} = 20 \text{ V}, R_{L} = 0.66 \Omega$		22	35			
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 30 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		24	36			
Fall Time	t <sub>f</sub>			8	16			
<b>Drain-Source Body Diode Characteris</b>	tics							
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			20	^		
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				50	A		
Body Diode Voltage	$V_{SD}$	I <sub>S</sub> = 10 A		0.84	1.2	V		
Body Diode Reverse Recovery Time	t <sub>rr</sub>			25	38	ns		
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	L 00 A dl/dt 100 A/vo T 05 °C		22	33	nC		
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = 20 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		15				
Reverse Recovery Rise Time	t <sub>b</sub>	7		10		ns		

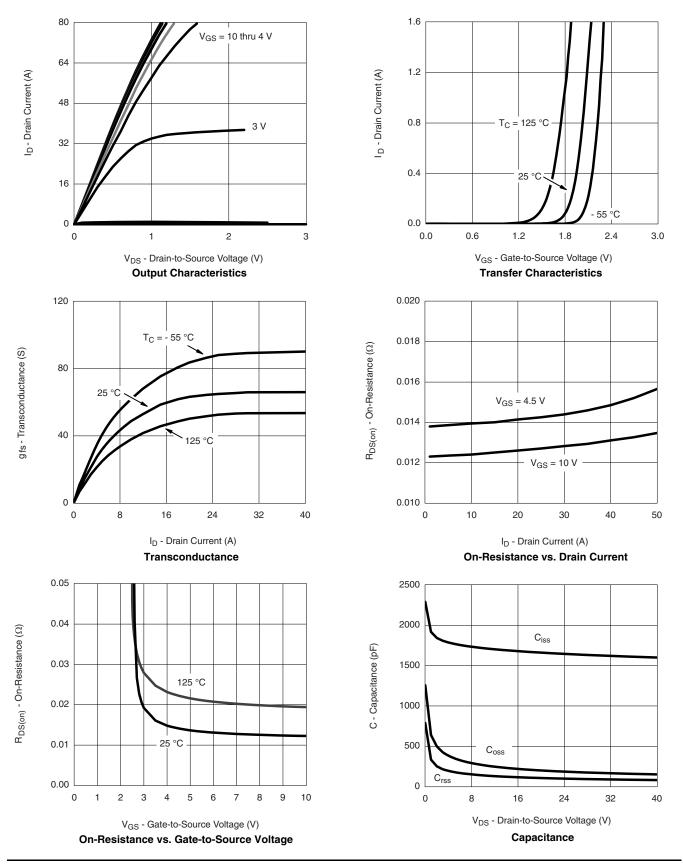
#### Notes:

- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

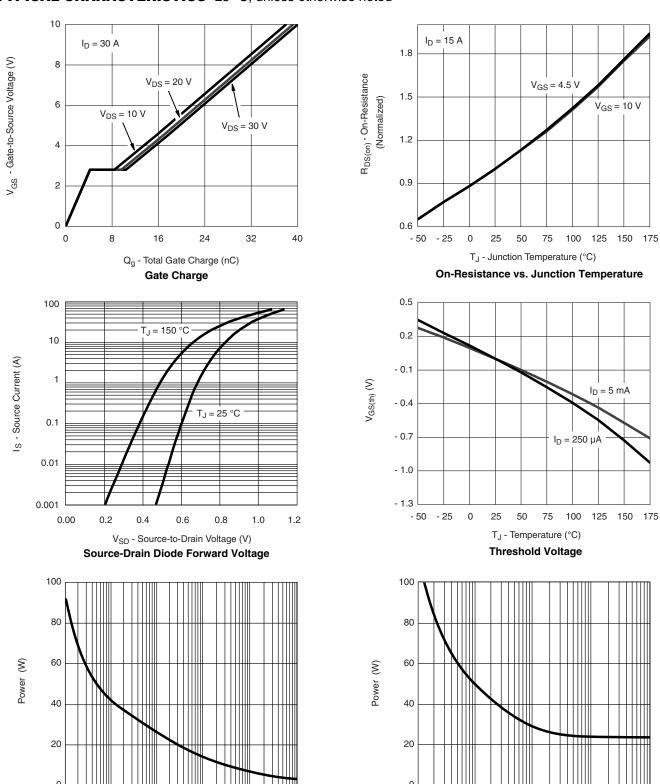


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## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



0.001

0.01

0.1

1

Time (s)

Single Pulse Power, Junction-to-Ambient

10

10

0.01

0.001

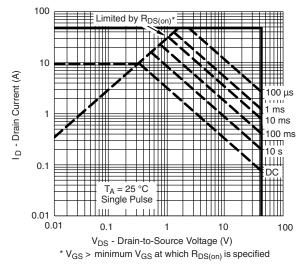
0.1

Time (s)

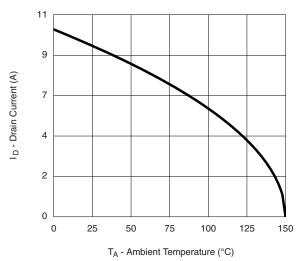
Single Pulse Power, Junction-to-Case



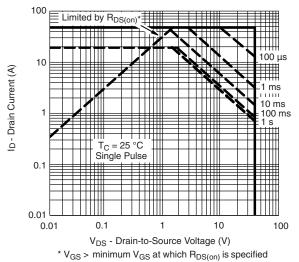
### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



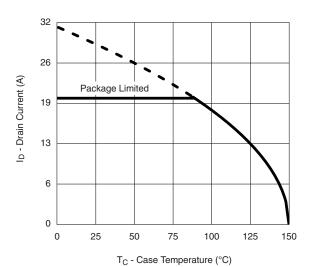
#### Safe Operating Area, Junction-to-Ambient



Current Derating\*\*, Junction-to-Ambient



Safe Operating Area, Junction-to-Case



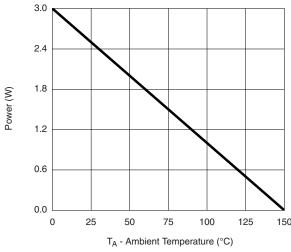
Current Derating\*\*, Junction-to-Case

<sup>\*\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 175 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

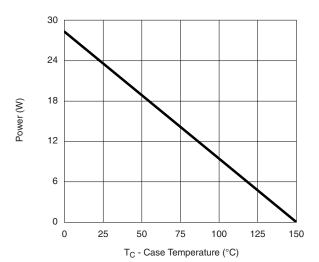
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## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





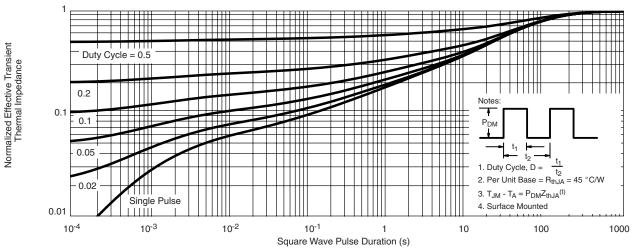


Power Derating\*, Junction-to-Case

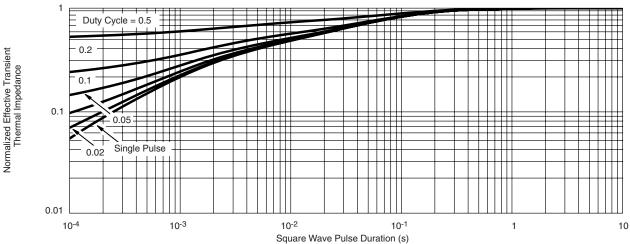
<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 175$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?74477">https://www.vishay.com/ppg?74477</a>.

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